



**ON Semiconductor®** 

# FDD3680

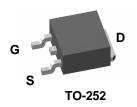
# 100V N-Channel PowerTrench<sup>o</sup> MOSFET

### **General Description**

This N-Channel MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers.

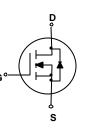
These MOSFETs feature faster switching and lower gate charge than other MOSFETs with comparable  $R_{DS(ON)}$  specifications.

The result is a MOSFET that is easy and safer to drive (even at very high frequencies), and DC/DC power supply designs with higher overall efficiency.



#### Features

- 25 A, 100 V.  $R_{DS(ON)} = 46 \text{ m}\Omega @ V_{GS} = 10 \text{ V}$  $R_{DS(ON)} = 51 \text{ m}\Omega @ V_{GS} = 6 \text{ V}$
- Low gate charge (38 nC typical)
- Fast switching speed
- High performance trench technology for extremely low R<sub>DS(ON)</sub>
- High power and current handling capability.



## Absolute Maximum Ratings T<sub>A=25°C</sub> unless otherwise noted

Symbol	Parameter		Ratings	Units
V <sub>DSS</sub>	Drain-Source Voltage		100	V
V <sub>GSS</sub>	Gate-Source Voltage		±20	V
b	Drain Current – Continuous	(Note 1)	25	A
	Drain Current – Pulsed		100	
PD	Maximum Power Dissipation	(Note 1)	68	W
		(Note 1a)	3.8	
		(Note 1b)	1.6	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range		-55 to +175	°C

# **Thermal Characteristics**

R <sub>0JC</sub>	Thermal Resistance, Junction-to-Case	(Note 1)	2.2	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1b)	96	°C/W

## Package Marking and Ordering Information

Device Marking	Device	Reel Size	Tape width	Quantity
FDD3680	FDD3680	13"	16mm	2500 units

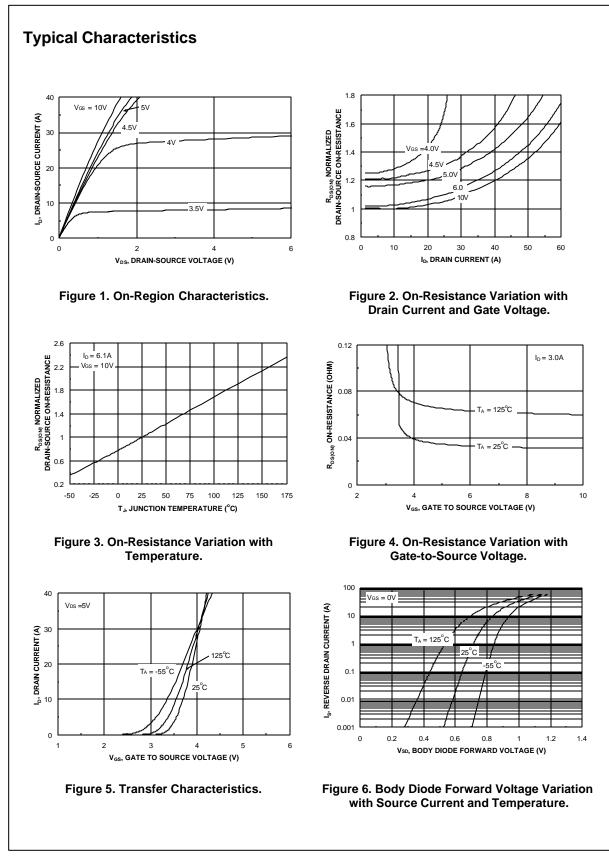
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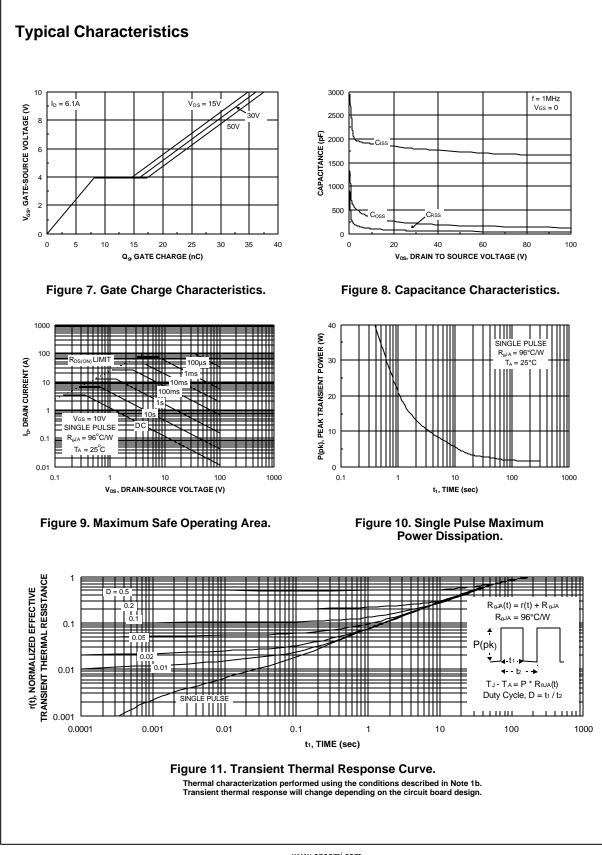
Symbol	Parameter	Test	t Conditions	Min	Тур	Max	Units
Drain-So	burce Avalanche Ratings (No	ote 1)					
W <sub>DSS</sub>	Single Pulse Drain-Source Avalanche Energy	$V_{DD} = 50 V,$	I <sub>D</sub> = 6.1 A			245	mJ
AR	Maximum Drain-Source Avalanche Current					6.1	A
Off Char	acteristics			1			
BV <sub>DSS</sub>	Drain–Source Breakdown	$V_{GS} = 0 V$ ,	lo = 250 uA	100			V
ΔBVDSS	Voltage Breakdown Voltage Temperature		eferenced to 25°C		-101		mV/°C
$\Delta T_J$	Coefficient						
DSS	Zero Gate Voltage Drain Current	$V_{DS} = 80 V,$	$V_{GS} = 0 V$			10	μA
GSSF	Gate–Body Leakage, Forward	$V_{GS} = 20 V$ ,				100	nA
GSSR	Gate–Body Leakage, Reverse	$V_{GS} = -20 V$	$V_{DS} = 0 V$			-100	nA
On Char	acteristics (Note 2)						
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS},$	I <sub>D</sub> = 250 μA	2	2.4	4	V
<u>ΔVGS(th</u> ) ΔTJ	Gate Threshold Voltage Temperature Coefficient	l <sub>D</sub> = 250 μA, R	eferenced to 25°C		-6.5		mV/°C
R <sub>DS(on)</sub>	Static Drain–Source	$V_{GS} = 10 V$ ,	I <sub>D</sub> = 6.1 A		32	46	mΩ
	On–Resistance	$V_{GS} = 10 V,$ $V_{GS} = 6 V,$	I <sub>D</sub> = 6.1 A, T <sub>J</sub> = 125°C I <sub>D</sub> = 5.8 A		61 34	92 51	
I <sub>D(on)</sub>	On–State Drain Current	$V_{GS} = 0 V$ , $V_{GS} = 10 V$ ,	$V_{DS} = 5 V$	25	04	01	А
g <sub>FS</sub>	Forward Transconductance	$V_{DS} = 5 V$ ,	$l_{\rm D} = 6.1 \rm{A}$		25		S
Dynamic	Characteristics	/					
Ciss	Input Capacitance	$V_{DS} = 50 V$ ,	$V_{GS} = 0 V,$		1735		pF
Coss	Output Capacitance	f = 1.0 MHz	/		176		pF
Crss	Reverse Transfer Capacitance				53		pF
Switchin	g Characteristics (Note 2)						
t <sub>d(on)</sub>	Turn–On Delay Time	$V_{DD} = 50 V$ ,	$I_{\rm D} = 1  {\rm A},$		14	25	ns
t <sub>r</sub>	Turn–On Rise Time	$V_{GS} = 10 V$ ,	$R_{GEN} = 10 \Omega$		8.5	17	ns
t <sub>d(off)</sub>	Turn–Off Delay Time				63	94	ns
t <sub>f</sub>	Turn–Off Fall Time				21	34	ns
Qg	Total Gate Charge	V <sub>DS</sub> = 50 V.	I <sub>D</sub> = 6.1 A,		38	53	nC
Q <sub>gs</sub>	Gate–Source Charge	$V_{GS} = 10 V$			8.1		nC
Q <sub>gd</sub>	Gate–Drain Charge				9.2		nC
-	ouros Diodo Charastaristia	o and Maxin	um Potingo				
ls	DURCE Diode Characteristic Maximum Continuous Drain–Sour					2.9	А
	Drain–Source Diode Forward				0.70	-	
V <sub>SD</sub>	Voltage	$V_{GS} = 0 V,$	$I_{\rm S} = 2.9 \text{ A}$ (Note 2)		0.73	1.3	V

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